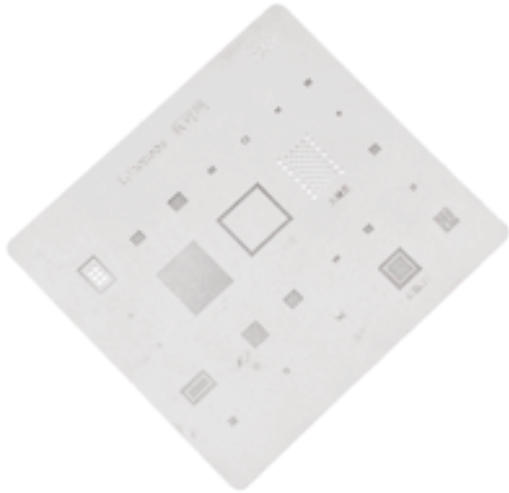


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BGA stencil for iPhone 5S (P3025)

Product ID: 17119

Price: **6.00 EUR**

Product weight: **0.10 kg**

Description:

BGA stencil for iPhone 5S (P3025) is chip ball template for BGA IC after reballing.

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